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CITATION:

Li, C.C. ...[et al]. Effects of Al doping on the thermoelectric performance of CoSi single crystal. JOURNAL OF APPLIED PHYSICS 2005, 98(6): 063706.

ISSUE DATE:

2005-09-15

URL:

<http://hdl.handle.net/2433/39716>

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Effects of Al doping on the thermoelectric performance of CoSi single crystal

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(Received 2 March 2005; accepted 1 August 2005; published online 19 September 2005)

Thermoelectric transport properties of $\text{CoSi}_{1-x}\text{Al}_x$ single crystals have been measured over the temperature range from 300 to 973 K to investigate the effects of Al substitution on the electrical resistivity, Seebeck coefficient, and thermal conductivity. The solubility limit of Al substitution for Si in CoSi is found to be in the range of $0.2 \leq x < 0.3$. The electrical resistivity increases with increasing Al substitution x and reaches a maximum at $x=0.08$. When x is further increased, there is a drop in the electrical resistivity between 300 and 550 K and there is almost no change at higher temperatures. The Seebeck coefficients of $\text{CoSi}_{1-x}\text{Al}_x$ single crystals shift towards the positive direction compared to that of the binary crystal over the entire measured temperature range. The Seebeck coefficient decreases as a function of temperature. The thermal conductivity and the figure of merit decrease significantly with increasing Al content. The decrease in thermal conductivity is mainly attributed to the additional scattering from Al atoms. © 2005 American Institute of Physics.
[DOI: [10.1063/1.2041843](https://doi.org/10.1063/1.2041843)]

I. INTRODUCTION

Some semiconducting transition-metal silicides have attracted considerable attention due to their practical applications in electronics and thermoelectrics.¹ CoSi with a $B20$ cubic structure has been reported to be a candidate for advanced thermoelectric applications.²⁻⁵ Band structure calculations^{1,6,7} show that there is a slight overlap of conduction and valence bands at the Fermi level, indicating that CoSi is a semimetal. Previous studies¹ on this compound indicated a moderate Seebeck coefficient value of $-83 \mu\text{V/K}$ at room temperature and a carrier concentration of about 10^{20} cm^{-3} . At room temperature, the extra carriers are electrons. The effective masses for holes and electrons are $6m_e$ and $2m_e$, respectively.^{1,3} In order to improve the thermoelectric performance of CoSi, doping has been attempted in this compound. It is known that CoSi forms a continuous solid solution with FeSi and dissolves up to 10% NiSi. The electron concentration increases with Ni substitution, but decreases with Fe substitution. Doping with Fe and Ni on the Co site resulted in increased electrical and thermal conductivities, especially at low temperatures.^{1,2} However, the thermoelectric power is decreased by Fe and Ni substitutions.^{1,2}

In recent years, doping with a third element on the Si site in CoSi has been attempted. Doping by B, Ge, and Al on the Si site has been reported in several recent works.⁸⁻¹⁰ In a

recent paper,¹⁰ the thermoelectric properties of polycrystalline Al-doped CoSi were reported in a temperature range of 0–300 K. In the present work, the Al-doped crystals of CoSi have been prepared by an optical-heating floating zone method. The solubility limit of Al substitution for Si has been determined. The effects of Al doping on the thermoelectric transport properties have been investigated in the temperature range of 300–973 K using single crystals to eliminate the effects from cast defects and grain boundaries. A possible mechanism has been discussed.

II. EXPERIMENTAL PROCEDURES

Ingots of $\text{CoSi}_{1-x}\text{Al}_x$ ($x=0-0.5$) were prepared by melting high-purity Co (99.98%), Si (99.999%), and Al (99.999%) in a laboratory-scale nonconsumable arc-melting furnace under a purified Ar atmosphere. The ingots were remelted six times and annealed at 1473 K for 24 h to ensure chemical homogeneity. Some of the ingots ($x=0.0, 0.04, 0.08, 0.12$, and 0.16) were melted into rods about 10 mm in diameter and 80 mm in length to grow single crystals. Crystal growth was performed in an optical-heating floating zone melting apparatus (Asgal FZ-20035 WHV) at a growth rate of 7–10 mm/hr in a high-purity Ar gas flow. Crystal structure, composition, microstructure, and perfection of the obtained ingots and crystals were characterized by powder x-ray diffraction (XRD, $\text{Cu } K\alpha$) and electron probe microanalyzer (EPMA). The orientation of the single crystals was determined by the Laue back-reflection method.

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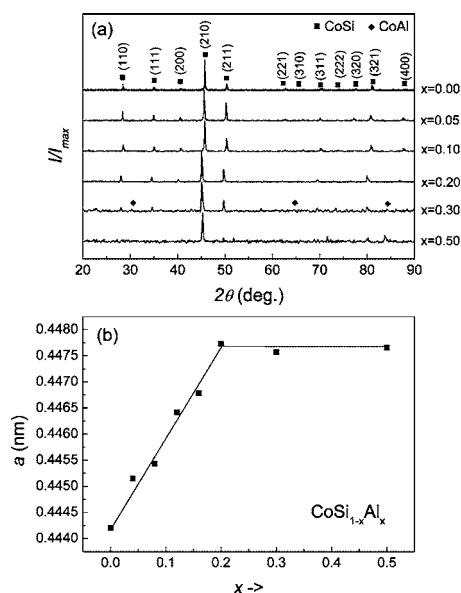


FIG. 1. (a) X-ray-diffraction patterns of $\text{CoSi}_{1-x}\text{Al}_x$ and (b) lattice parameter vs Al concentration as obtained from x-ray diffraction.

Electrical resistivity ρ and Hall coefficient R_H were measured in a temperature range from 300 to 973 K using the van der Pauw technique under an argon atmosphere. Carrier concentration n was determined from the measured Hall coefficient R_H using the $n=1/R_H e$ relation, where e is the electron charge. Seebeck coefficient S was measured by applying a small temperature difference (3 K) to the two ends of a specimen in a temperature range from 300 to 973 K under an argon atmosphere. Thermal conductivity κ ($\kappa=DC_p d$) was calculated from the experimental values of thermal diffusivity D , specific heat capacity C_p , and density d . The thermal diffusivity was measured by an ac calorimetry method from 300 to 473 K. The specific heat capacity was measured by a differential scanning calorimeter (DSC) in an Ar flow.

III. RESULTS AND DISCUSSIONS

Figures 1(a) and 1(b) show the x-ray-diffraction patterns of $\text{CoSi}_{1-x}\text{Al}_x$ and the determined lattice parameter as a function of Al concentration, respectively. When $x \leq 0.2$, the $\text{CoSi}_{1-x}\text{Al}_x$ ingots are all of monolithic CoSi phase, whose lattice parameter increases linearly with increasing x . This indicates that the Si sites are substituted by Al atoms according to Vegard's law, which is consistent with a previous work.¹⁰ When $x \geq 0.30$, B2-type CoAl phase besides CoSi is identified in the microstructure as indicated in Fig. 1(a). The lattice parameter of the CoSi phase is almost constant in this composition range. Figure 2 displays a typical backscattered electron image of $\text{CoSi}_{0.7}\text{Al}_{0.3}$. The analyzed compositions of phases "A" and "B" are listed in Table I. The Co contents in the two phases are very close to 50 at. %, while A is obviously richer in Al than B is. The determined composition of phase A (B2-type CoSi structure) can be expressed as $\text{Co}_{1.06}\text{Si}_{0.77}\text{Al}_{0.23}$. Therefore, it can be concluded that the solubility limit of Al in $\text{CoSi}_{1-x}\text{Al}_x$ is in the range of $0.2 \leq x < 0.3$.

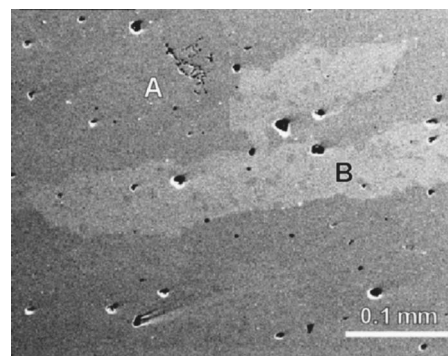


FIG. 2. Backscattered electron image of $\text{CoSi}_{0.7}\text{Al}_{0.3}$ annealed at 1473 K for 24 h (A: CoSi phase, B: CoAl phase).

The temperature dependence of the electrical resistivity of $\text{CoSi}_{1-x}\text{Al}_x$ is shown in Fig. 3(a), compared with the data for binary CoSi (dashed line) reported in the literature.¹ It can be found that the electrical resistivity increases dramatically with increasing Al concentration in $\text{CoSi}_{1-x}\text{Al}_x$ and reaches a maximum at $x=0.08$. Further increase of Al concentration results in a slight decrease of electrical resistivity in the temperature range from 300 to 550 K; while the electrical resistivity is almost unchanged at higher temperatures [Fig. 3(a)]. Figure 3(b) compares the dependence of room-temperature electrical resistivity on Al concentration x in $\text{CoSi}_{1-x}\text{Al}_x$. For binary CoSi, the electrical resistivity of CoSi in this study is slightly higher than that in Ref. 1 and is almost one order of magnitude smaller than that in Ref. 10. In Ref. 10, it shows that the electrical resistivity decreases continuously with increasing x , which is fully different from our results. Since the specimens used in Ref. 10 were arc-melted polycrystals, the measured electrical resistivity is very sensitive to cast defects such as cracks in microstructure. It is shown from the Hall measurement that Al doping increases the carrier concentration [Fig. 3(b)]. The increased carrier concentration in a semimetal such as CoSi would simultaneously enhance the scattering between carriers, leading to an apparent increase in electrical resistivity by Al doping.

The temperature dependence of the Seebeck coefficient of $\text{CoSi}_{1-x}\text{Al}_x$ single crystals is shown in Fig. 4(a), compared with the data for binary CoSi (dashed line) reported in the literature.¹ For comparison, the dependence of the Seebeck coefficient at room temperature on Al concentration x is plotted in Fig. 4(b) together with the data from the literatures.^{1,8} For binary CoSi, the measured S value is very close to that in the literature^{1,8} (Fig. 4). The negative S values of binary CoSi indicate electron-type conduction over the investigated temperature range, consistent with the previous results.^{1,2,4} Upon Al substitution, the S value of $\text{CoSi}_{1-x}\text{Al}_x$ increases. At room

TABLE I. Compositions of the phases marked as "A" and "B" in Fig. 2 determined by EPMA (in at. %).

Phase	Co	Si	Al
A	51.40	37.18	11.42
B	49.98	20.36	29.66

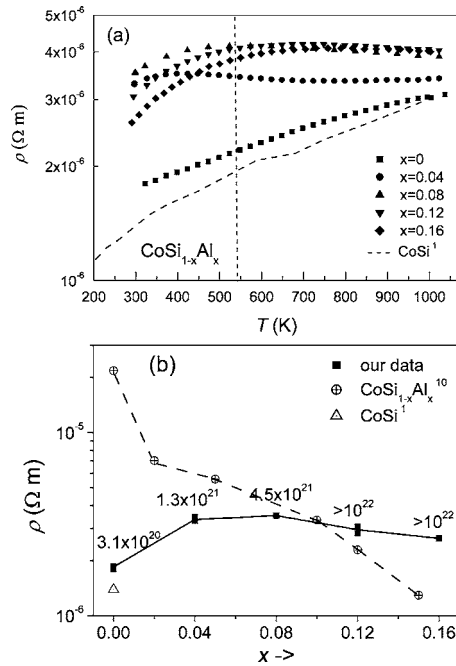


FIG. 3. Electrical resistivity of $\text{CoSi}_{1-x}\text{Al}_x$ single crystals (a) vs temperature and (b) at room temperature [the numbers indicate the measured carrier density (cm^{-3})].

temperature, the sign of S changes from negative to positive at around $x=0.04$ [Fig. 4(b)]. Contrary to electrical resistivity, our measured S values are very close to the reported data,^{1,2,4} probably due to the reason that the Seebeck coefficient is relatively insensitive to defects in the specimen. Figure 4(a) shows that for the Al-doped specimens, the S value decreases with increasing temperature. The sign of S changes from positive at low temperatures to negative at high temperatures. The temperature at which the sign reverses increases when Al concentration increases (Fig. 4(a)). For example, when $x=0.04$, the transition temperature is about 320 K, and when $x=0.16$, the transition temperature is about 720 K. This should be attributed to the change of hole concentration by Al doping. The observed Seebeck coefficients can be understood within the framework of a two-carrier conduction model. According to this model, the total S can be expressed as¹⁰

$$S = \frac{\sigma_h S_h + \sigma_e S_e}{\sigma_h + \sigma_e}, \quad (1)$$

where $S_{p,n}$ and $\sigma_{p,n}$ represent the Seebeck coefficients and electrical conductivities for the p - and n -type carriers, respectively. Since the signs of S_p and S_n are opposite, increasing the hole concentration by Al doping could result in a sign change in S . This is actually what we observed in the present study. However, the absolute S value of $\text{CoSi}_{1-x}\text{Al}_x$ is considerably smaller than that of binary CoSi.

Within the two-carrier conduction scenario, the electron mobility is much higher than that of holes due to the smaller effective mass. Moreover, from the band-structure calculations,^{1,7} the electron pockets are larger than the hole pockets. Therefore, the observed Seebeck coefficient of binary CoSi at room temperature is negative. When Al substitutes for Si, hole concentration increases leading to a p -type

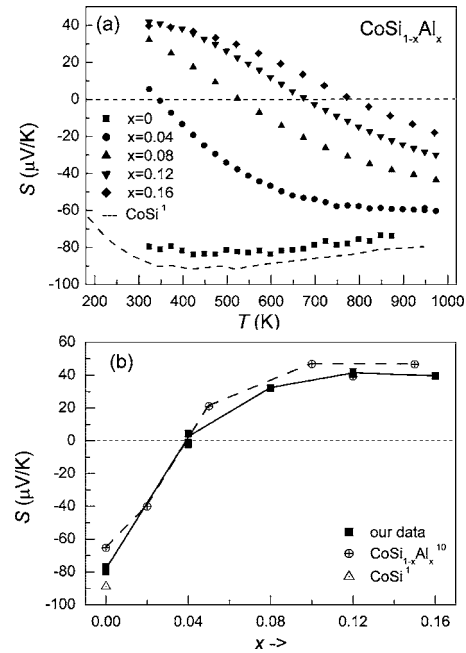


FIG. 4. Seebeck coefficient of $\text{CoSi}_{1-x}\text{Al}_x$ single crystals (a) vs temperature and (b) at room temperature.

conductivity, as illustrated in the present study. Our recent band-structure calculation⁷ shows that the Fermi level shifts downwards after Al doping. This downward shift reduces the bottom of the upper band for the electron but enlarges the top of the lower band for the hole, yielding the p -type carriers that dominate the transport behavior. This is highly consistent with the present observations. With increasing Al concentration, it is reasonable to anticipate that the hole concentration increases further. Therefore, more thermally excited electrons are needed to balance the extra holes. This may explain why S changes its sign at a higher temperature under a higher Al concentration.

Figure 5(a) shows the temperature dependence of the thermal conductivity of $\text{CoSi}_{1-x}\text{Al}_x$ single crystals. Compared to the data for binary CoSi polycrystal,¹ the measured thermal conductivity of CoSi single crystal is slightly lower. The thermal conductivity of the binary CoSi crystal decreases with temperature. The effect of Al substitution on lowering the thermal conductivity is clear from the plot. For Al-doped specimens, a general trend in thermal conductivity is that the thermal conductivity first decreases and then increases slightly with temperature. For the heavily doped specimen ($x=0.16$), the thermal conductivity decreases continuously with temperature, probably due to the reason that the transition temperature is outside the investigated temperature range.

Thermal conductivity κ for semimetals can be divided into two parts: the carrier contribution κ_{car} and the lattice contribution κ_{lat} . The carrier contribution part κ_{car} can be estimated from the Wiedemann-Franz relationship $\kappa_{\text{car}} = L_0 T / \rho$, where L_0 is the Lorentz number ($L_0 = 2.44 \times 10^{-8} \text{ W } \Omega / \text{K}^2$),¹⁰ ρ is the electrical resistivity, and T is the absolute temperature. The lattice contribution κ_{lat} is obtained by subtracting κ_{car} from the observed thermal conductivity κ . As shown in Fig. 5(b), the lattice contribution κ_{lat} is pre-

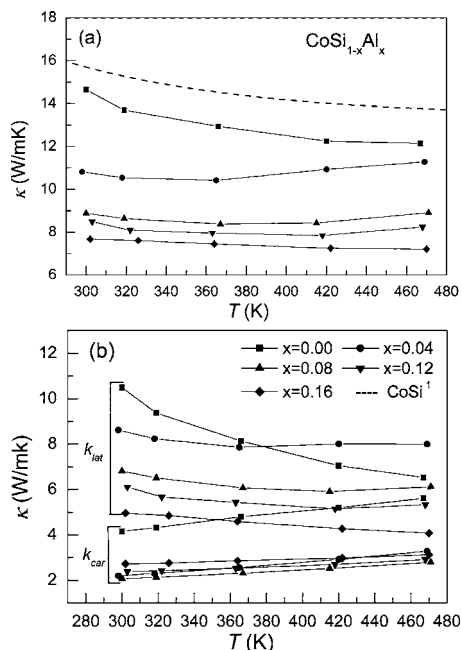


FIG. 5. (a) Thermal conductivity of $\text{CoSi}_{1-x}\text{Al}_x$ single crystals vs temperature. (b) Lattice thermal conductivity (k_{lat}) and carrier thermal conductivity (k_{car}) of $\text{CoSi}_{1-x}\text{Al}_x$ single crystals vs temperature.

dominant in the total thermal conductivity. The electron contribution of all the investigated specimens increases almost linearly with temperature. This may be attributed to an increase in thermally activated carrier density. The temperature dependence of the lattice contribution of binary CoSi is roughly proportional to $1/T$, indicating that the decrease in thermal conductivity is mainly caused by thermal vibration. Both the lattice and electron contributions decrease after Al doping. For the doped specimens, the temperature dependence of the lattice contribution is relatively weak, which is different from that of the binary one. This may imply that Al substitution for Si in CoSi would introduce additional phonon scattering which in turn results in a decreased thermal conductivity. Since the additional scattering is caused by the dopant Al instead of the thermally activated carrier, the temperature dependence of thermal conductivity would be weak. Lue *et al.*¹⁰ has also observed a similar decrease in thermal conductivity by Al doping and attributed it to point defects.

In practical application, the performance of a thermoelectric material is characterized by the dimensionless figure of merit $ZT = S^2T/\rho\kappa$.¹¹ Figure 6 shows ZT value as a function of temperature for all the samples. It can be found that Al doping significantly decreases the ZT of CoSi . This is largely attributed to the significant decrease of electrical transport properties by Al doping, though thermal conductivity decreases after doping in the meanwhile.

IV. CONCLUSION

The effects of Al substitution for Si on the thermoelectric performance of CoSi were investigated in the temperature range from 300 to 973 K. The solubility limit of Al in

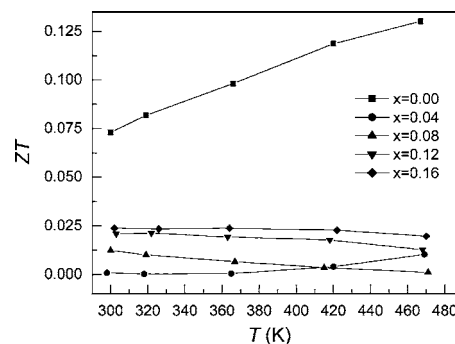


FIG. 6. ZT values of $\text{CoSi}_{1-x}\text{Al}_x$ single crystals vs temperature.

$\text{CoSi}_{1-x}\text{Al}_x$ is found to be in the range of $x = 0.20$ – 0.30 . The $B2$ -type CoAl phase forms in the microstructure when $x \geq 0.3$. There is substantial increase in electrical resistivity upon Al substitution. At high doping levels ($x \geq 0.08$), the electrical resistivity decreases slightly in the temperature range from 300 to 550 K and remains almost unchanged at higher temperatures with increasing x . The Seebeck coefficient of the undoped CoSi is negative within the investigated temperature range. For the substituted specimens, the sign of the Seebeck coefficient changes from positive to negative with increasing temperature. The reverse point is at a higher temperature with increasing Al concentration. However, the absolute value of the Seebeck coefficient is lowered by Al substitution. Thermal conductivity is significantly reduced by Al substitution. Both the lattice and carrier contributions to thermal conductivity are decreased, but the decrease in lattice contribution is much larger. The ZT of CoSi is significantly reduced by Al substitution. This mainly results from the decrease in electrical transport properties.

ACKNOWLEDGMENTS

This work was supported by the Shanghai-Applied Materials Research and Development Foundation (Contract No. 0317) and the National Natural Science Foundation of China (Contract No. 50131030). One of the authors (W.L.R.) acknowledges the China and Shanghai Postdoctoral Science Foundation for their financial support.

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